

2SA0683, 2SA0684 (2SA683, 2SA684)

Silicon PNP epitaxial planer type

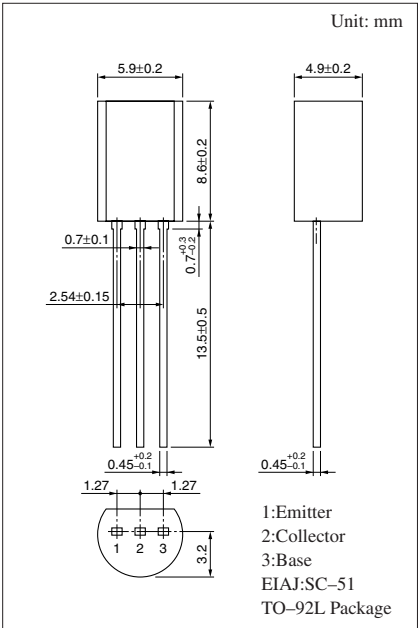
For low-frequency power amplification and driver amplification
Complementary to 2SC1383 and 2SC1384

Features

- Complementary pair with 2SC1383 and 2SC1384.
- Allowing supply with the radial taping.

Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit
Collector to base voltage	2SA0683	V _{CBO}	-30	V
	2SA0684		-60	
Collector to emitter voltage	2SA0683	V _{CEO}	-25	V
	2SA0684		-50	
Emitter to base voltage		V _{EBO}	-5	V
Peak collector current		I _{CP}	-1.5	A
Collector current		I _C	-1	A
Collector power dissipation		P _C	1	W
Junction temperature		T _j	150	°C
Storage temperature		T _{stg}	-55 ~ +150	°C



Electrical Characteristics (Ta=25°C)

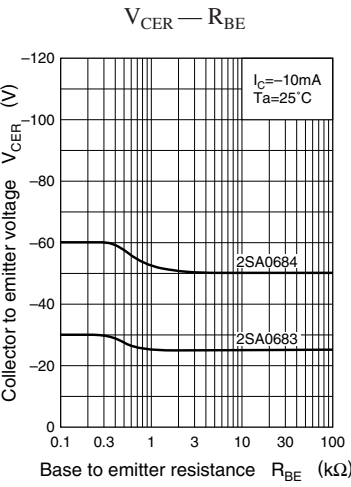
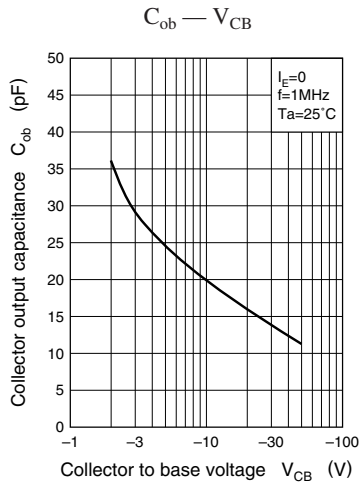
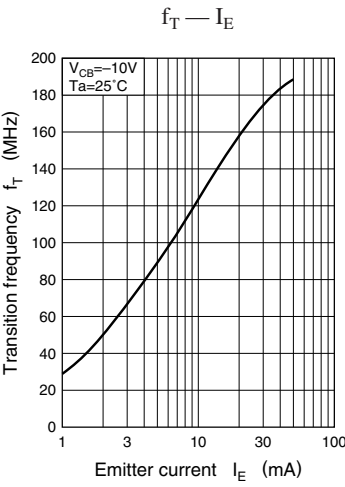
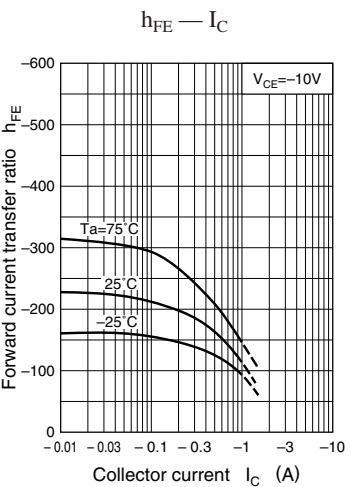
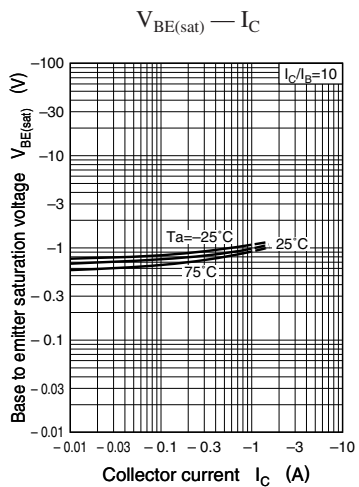
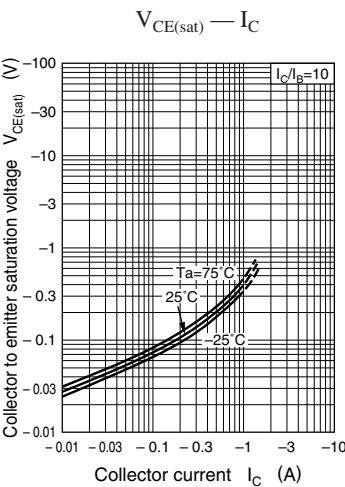
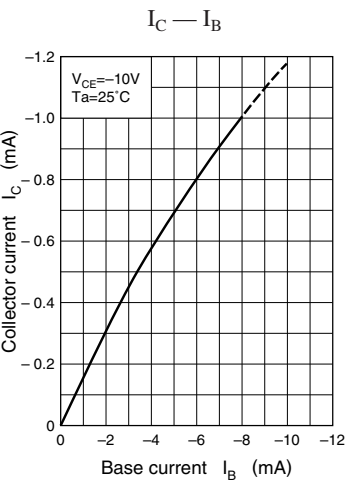
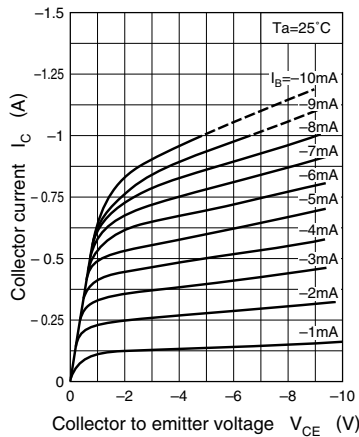
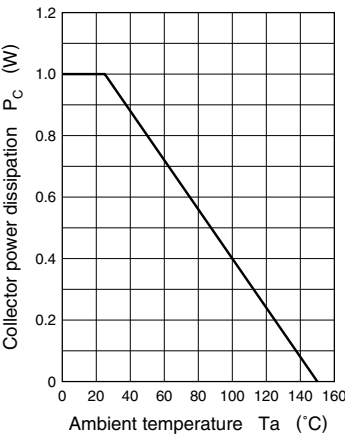
Parameter		Symbol	Conditions	min	typ	max	Unit
Collector cutoff current		I _{CBO}	V _{CB} = -20V, I _E = 0			- 0.1	μA
Collector to base voltage	2SA0683	V _{CBO}	I _C = -10μA, I _E = 0	-30			V
	2SA0684			-60			
Collector to emitter voltage	2SA0683	V _{CEO}	I _C = -2mA, I _B = 0	-25			V
	2SA0684			-50			
Emitter to base voltage		V _{EBO}	I _E = -10μA, I _C = 0	-5			V
Forward current transfer ratio		h _{FE1} *	V _{CE} = -10V, I _C = -500mA	85		340	
		h _{FE2}	V _{CE} = -5V, I _C = -1A	50			
Collector to emitter saturation voltage		V _{CE(sat)}	I _C = -500mA, I _B = -50mA		- 0.2	- 0.4	V
Base to emitter saturation voltage		V _{BE(sat)}	I _C = -500mA, I _B = -50mA		- 0.85	-1.2	V
Transition frequency		f _T	V _{CB} = -10V, I _E = 50mA, f = 200MHz		200		MHz
Collector output capacitance		C _{ob}	V _{CB} = -10V, I _E = 0, f = 1MHz		20	30	pF

*h_{FE1} Rank classification

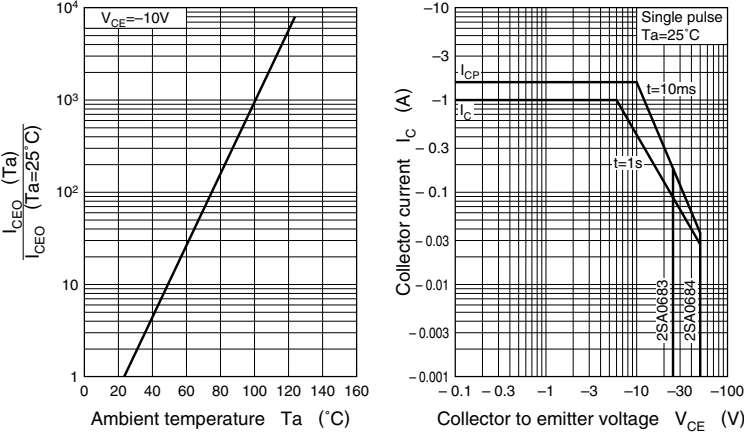
Rank	Q	R	S
h _{FE1}	85 ~ 170	120 ~ 240	170 ~ 340

Note.) The Part numbers in the Parenthesis show conventional part number.

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